



| Form PTO 1449 (Modified) | | U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | | ATTY DOCKET NO. 280953US0PCT | | SERIAL NO. 10/556,720 | |
|--|----|--|----------|--------------------------------------|-----------------------|--|-------------------------------|
| LIST OF REFERENCES CITED BY APPLICANT | | | | APPLICANT Kosuke WATANABE, et al. | | | |
| | | | | FILING DATE November 14, 2005 | | GROUP | |
| U.S. PATENT DOCUMENTS | | | | | | | |
| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
| | AA | | | | | | |
| | AB | | | | | | |
| | AC | | | | | | |
| | AD | | | | | | |
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| | AL | | | | | | |
| | AM | | | | | | |
| | AN | | | | | | |
| FOREIGN PATENT DOCUMENTS | | | | | | | |
| | | DOCUMENT NUMBER | DATE | COUNTRY | TRANSLATION YES NO | | |
| /K.E./ | AO | 2002-53703 | 02/19/02 | JP | | NO | |
| /K.E./ | AP | 2000-303043 | 10/31/00 | JP | | NO | |
| /K.E./ | AQ | 2003-136182 | 05/14/03 | JP | | NO | |
| /K.E./ | AR | 2003-144332 | 05/22/03 | JP | | NO | |
| /K.E./ | AS | 2004-109691 | 04/02/04 | JP | | NO | |
| /K.E./ | AT | 2004-121135 | 04/16/04 | JP | | NO | |
| | AU | | | | | | |
| | AV | | | | | | |
| OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.) | | | | | | | |
| /K.E./ | AW | "Adhesion Technology", Vol. 21, No. 4, page 17, 2.2.2.2., Serial Number 65, 2002 | | | | | |
| /K.E./ | AX | YOSHIDA Tokiyuki et al., "New Edition Surfactant Handbook", Kougakutoshio Ltd., Page 234, 2000 | | | | | |
| /K.E./ | AY | JIS K6387-2, 2003 (with partial English Translation) | | | | | |
| | AZ | | | | | <input type="checkbox"/> Additional References sheet(s) attached | |
| Examiner | | | | /Kelechi Egwim/ (09/28/2008) | | Date Considered | |

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.